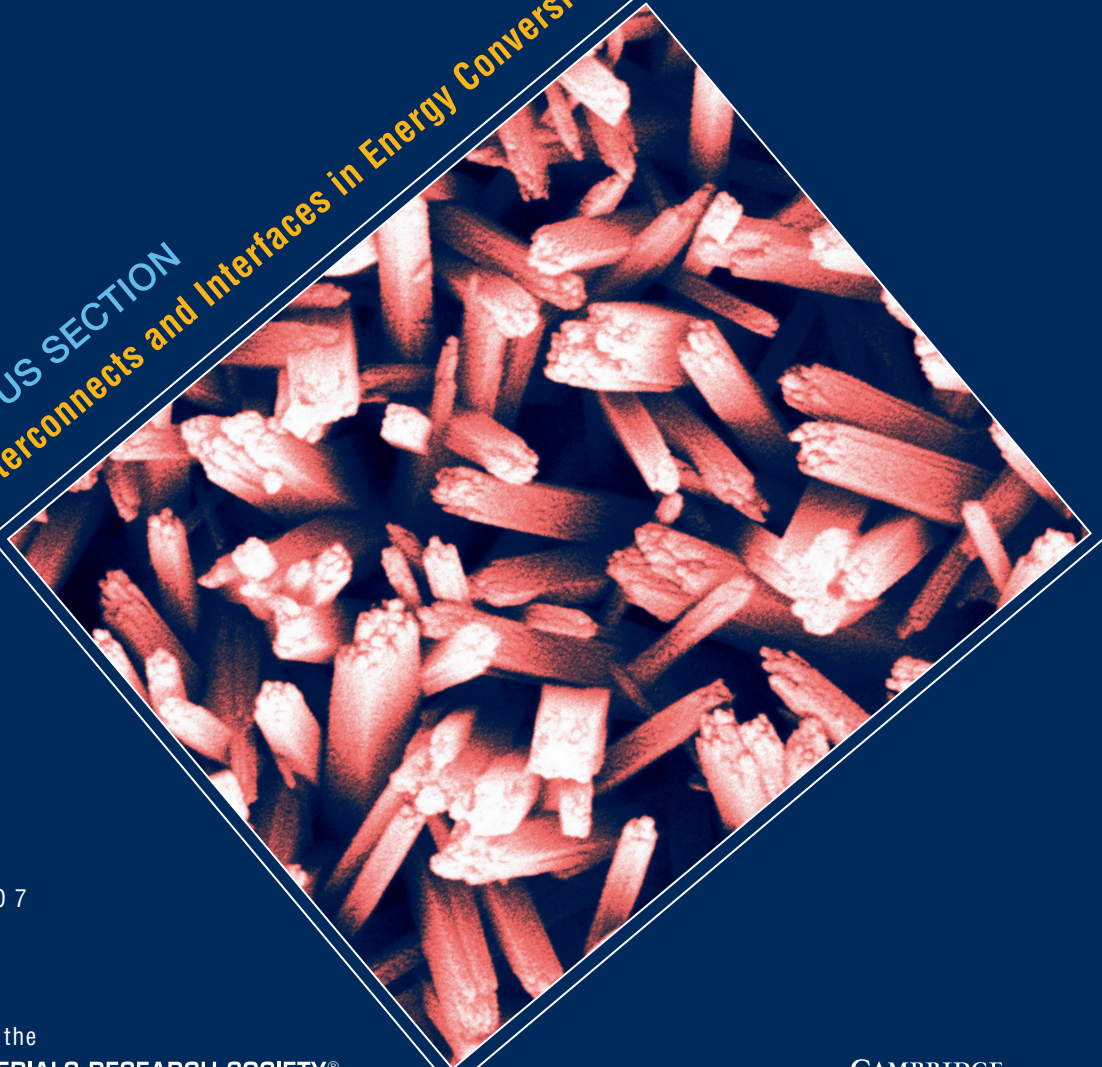




Journal of  
MATERIALS RESEARCH

FOCUS SECTION  
Interconnects and Interfaces in Energy Conversion Materials



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